- SDLS054
  - '150 Selects One-of-Sixteen Data Sources
  - Others Select One-of-Eight Data Sources
  - All Perform Parallel-to-Serial Conversion
  - All Permit Multiplexing from N Lines to One Line
  - Also For Use as Boolean Function Generator
  - Input-Clamping Diodes Simplify System Design
  - Fully Compatible with Most TTL Circuits

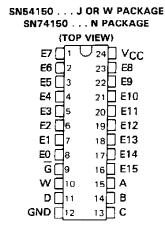
	TYPICAL AVERAGE	TYPICAL
TYPE	PROPAGATION DELAY TIME	POWER
	DATA INPUT TO W OUTPUT	DISSIPATION
150	13 ns	200 mW
151A	8 ns	145 mW
'LS151	13 ns	30 mW
'S151	4.5 ns	225 mW

### description

These monolithic data selectors/multiplexers contain full on-chip binary decoding to select the desired data source. The '150 selects one-of-sixteen data sources; the '151A, 'LS151, and 'S151 select one-of-eight data sources. The '150, '151A, 'LS151, and 'S151 have a strobe input which must be at a low logic level to enable these devices. A high level at the strobe forces the W output high, and the Y output (as applicable) low.

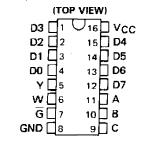
The '150 has only an inverted W output; the '151A, 'LS151, and 'S151 feature complementary W and Y outputs.

The '151A and '152A incorporate address buffers that have symmetrical propagation delay times through the complementary paths. This reduces the possibility of transients occurring at the output(s) due to changes made at the select inputs, even when the '151A outputs are enabled (i.e., strobe low).

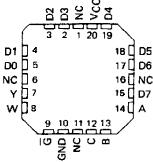


SN54151A, SN54LS151, SN54S151 . . . J OR W PACKAGE SN74151A . . . N PACKAGE

SN74LS151, SN74S151 . . . D OR N PACKAGE



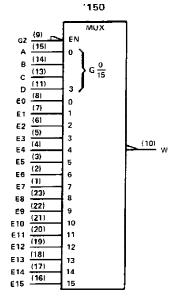
SN54LS151, SN54S151 . . . FK PACKAGE (TOP VIEW)

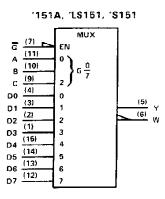


NC - No internal connection

# SN54150, SN54151A, SN54LS151, SN54S151, 查询"\$N741每0,0\$N茶41药 DATA SELECTORS/MULTIPLEXERS

# logic symbols†





<sup>†</sup>These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are D, J, N, and W packages.

'150 FUNCTION TABLE

L_		IN	PUT	S	OUTPUT
	SEL	ECT	•	STROBE	w
0	С	В	_A	Ğ	¥V
х	Х	Х	Х	н	π
L	L	L	L	L	ΕÖ
L	L	L	H	L	E1
L	L	H	L	L	E2
L	L	Н	н	L	Ē3
L	Н	L	L	L	Ē4
L	н	L	Η :	L	E5
L	н	Н	Ļ	L	<u>E6</u>
L	н	Н	н	L	Ē7
н	L	L	Ł	L	€8
н	L	L	H	L	Ē9
Н	L	н	L	L	E10
н	L	н	н	L	E11
н	н	L	L	L	E12
н	Н	L	н	L	E13
н	Н	Н	L	L	E14
н	н	Н	н	L	E15

'151A, 'LS151, 'S151 FUNCTION TABLE

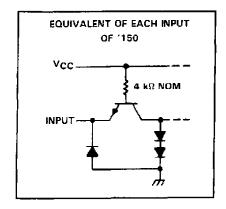
	H	NPUT	S	out	PUTS
S	ELEC	:Т	STROBE	v	w
С	В	A	Ğ	*	**
Х	Х	Х	Н	L	Н
L	L	L	L	DO	<u>50</u>
L	L L H		L	D1	D1
L	Н	L	L	D2	02
L	н	Н	L	D3	<b>D</b> 3
Н	L	L	L	D4	D4
н	H L H		L	D5	D5
н			L	D6	D6
Н	Н	Н	L	D7	D7

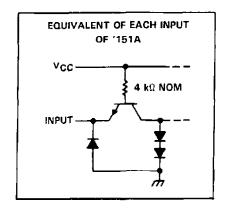
H = high level, L = low level, X = irrelevant

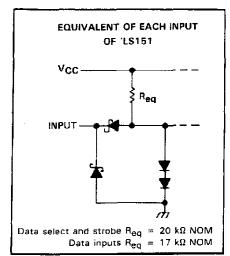
 $\overline{E0}$ ,  $\overline{E1}$  ...  $\overline{E15}$  = the complement of the level of the respective E input

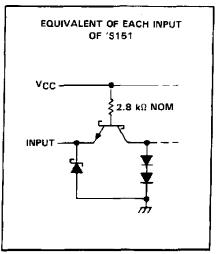
DO, D1 . . . D7 = the level of the D respective input

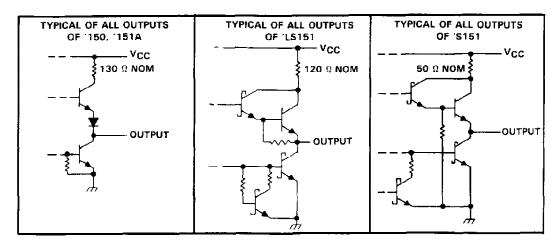
# schematics of inputs and outputs











# SN54150, SN54151A, SN74150, SN74151A 查询 BAPA SELECTORS MULTIPLEXERS

# recommended operating conditions

		SN54'			SN74'		
<u></u>	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH		-	-800			-800	μΑ
Law-level output current, IOL			16			16	mΑ
Operating free-air temperature, TA	-55		125	0		70	·C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	CA CAMPTED	TEST CONDI	TIONST		1150			151A		146147
	PARAMETER 	TEST CONDI	TIONS.	MIN	TYP <sup>‡</sup>	MAX	MIN	TYP‡	MAX	UNIT
VιΗ	High-level input voltage			2			2			٧
VIL	Low-level input voltage			•		0.8			0.8	٧
VIK	Input clamp voltage	VCC = MIN. I	= -8 mA			- 1.5			-1.5	V
∨он	High-level output voltage	$V_{CC} = MIN, V_{H}$ $V_{IL} = 0.8 \text{ V}, I_{OI}$	· 1	2.4	3.4		2.4	3.4		V
VOL	Low-level output voltage	$V_{CC} = MIN, V_{II}$ $V_{IL} = 0.8 \text{ V}, I_{OI}$			0.2	0.4		0.2	0.4	٧
l <sub>j</sub>	Input current at maximum input voltage	VCC = MAX, V	= 5.5 V			1 ,			1	mΑ
lite	High-level input current	VCC = MAX, VI	= 2.4 V			40			40	μА
l <sub>IL</sub>	Low-level input current	$V_{CC} = MAX, V_I$	= 0.4 V		·	-1.6			-1.6	mA
		14 MANY	SN54'	- 20		- 55	- 20		- 55	
los	Short-circuit output current <sup>9</sup>	V <sub>CC</sub> = MAX	SN74'	- 18		- 55	-18		- 55	mA
lcc	Supply current	V <sub>CC</sub> = MAX, See	Note 3		40	68		29	48	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

# switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER*	FROM	TO	TEST		'150			151/	4	
PARAMETER	(INPUT)	(OUTPUT)	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
tPLH .	A, B, or C	Y						25	38	
<sup>‡</sup> PHL	(4 levels)	,						25	38	пş
<sup>t</sup> PLH	A, B, C, or D	w		_	23	35		17	26	
<sup>†</sup> PHL	(3 levels)				22	33		19	30	ns
<sup>₹</sup> PŁH	Strobe G	Y	CL = 15 pF,					21	33	ns
tPHL .	Strope G	•	$R_L = 400 \Omega$ ,					22	33	1115
tPLH	Strobe G	W	See Note 4 j		24		14	21	ns	
<sup>t</sup> PHL	Strope G		000 17010 17		21	30		15	23	''3
†PLH	DO thru D7	Y						13	20	
<sup>Ţ</sup> PHŁ	Bo mild D7	<u> </u>						18	27	ns
tPLH	E0 thru E15, or	w			8.5	14		8	14	
tPHL .	D0 thru D7	••			13	20		8	14	ns



<sup>†</sup> All typical values at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25 ^{\circ}\text{C}$ .

Not more than one output of the '151A should be shorted at a time.

NOTE 3: ICC is measured with the strobe and data select inputs at 4.5 V, all other inputs and outputs open.

 $_{\text{tp}LH}^{\P}$  = propagation delay time, low-to-high-level output tpHL = propagation delay time, high-to-low-level output NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

# recommended operating conditions

	S	N54LS	151	Si	N74LS1	51	LINICT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	b,b	4.75	5	5.25	٧
High-level output current, IOH			-400			-400	μА
Low-level output current, IOL			4			8	mA
Operating free-air temperature, TA	-65		125	0		70	C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS!		s	N54L\$1	51	s	N74LS1	51	
	PANAMETER	TEST CONDITIONS†		MIN	TY₽‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			2			V
$V_{IL}$	Low-level input voltage					0.7			0.B	٧
Vik	Input clamp voltage	V <sub>CC</sub> = MIN, I <sub>1</sub> = -18 mA				- 1.5			-1.5	V
VOH	High-level output voltage	$V_{CC}$ = MIN, $V_{IH}$ = 2 V, $V_{IL}$ = $V_{IL}$ max, $I_{OH}$ = $-400 \mu$	A	2.5	3.4	-	2.7	3.4		٧
.,	·	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, I <sub>O</sub>	L = 4 mA		0.25	0.4		0.25	0.4	
VOL	Low-level output voltage	VIL = VILmax	լ – 8 mA		-			0.35	0.5	٧
lį	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>1</sub> = 7 V				0.1			0.1	mA
Ιн	High-level input current	V <sub>CC</sub> - MAX, V <sub>1</sub> - 2.7 V				20			20	μΑ
ηL	Low-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V	ĺ			-0.4			-0.4	mΑ
los	Short-circuit output current§	V <sub>CC</sub> = MAX	-	- 20		- 100	- 20		- 100	mΑ
lcc	Supply current	V <sub>CC</sub> = MAX, Outputs open, All inputs at 4.5 V			6.0	10		6.0	10	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

# switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> 25 °C

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	דואט
<sup>†</sup> PLH	A, B, or C	Y			27	43	
<sup>t</sup> PHL	(4 levels)	r	]		18	30	ns
tPLH	A, B, or C	W			14	23	
tPHL	(3 levels)	¥¥			20	32	ns
tPLH .	Strobe G	Y	0 - 15 - 5		26	42	
t <sub>PHL</sub>	311006.0	Lidde d	Cլ = 15 pF,		20	32	ns
<sup>†</sup> PLH	Strobe G	W	- R <sub>L</sub> – 2 kΩ, See Note 4		15	24	ns
tPHL	Strope G	VV	See Note 4		18	30	115
t <sub>PLH</sub>	A=D	Any D Y Any D W		20	32		
tPHL	Any U			16	26	ns	
tPLH_	Amu D			13	21		
†PHL	Any b				12	20	ns

¶tpLH = propagation delay time, low-to-high-level output tpHL = propagation delay time, high-to-low-level output NOTE 4: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>^{\</sup>ddagger}$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C.  $^{\$}$  Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.

# recommended operating conditions

	S	SN54S151			SN74S151			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	ν	
High-level output current, IOH			-1			-1	mΑ	
Low-level output current, IOL			20			20	πА	
Operating free-air temperature, TA	55		125	0		70	°C	

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONST		MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					0.8	V
Vik	Input clamp voltage	V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA				-1.2	V
· · · · ·	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,	SN54S151	2.5	3.4		
νон	riign-rever ou tout vortage	VIL = 0.8 V, IOH = -1 mA	SN74S151	2.7	3.4		V
VOL	Low-level output voltage	VCC = MIN, VIH = 2 V,	-			0.5	v
VOL	Low-level output voltage	V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 20 mA	i			0.5	v
l <sub>1</sub>	Input current at maximum input voltage	VCC = MAX, V1 = 5.5 V				1	mA
ΉН	High-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V				50	μА
1 <sub>IL</sub>	Low-level input current	V <sub>CC</sub> - MAX, V <sub>I</sub> = 0.5 V				-2	mA
los	Short-circuit output current 8	V <sub>CC</sub> = MAX		-40		-100	mA
¹cc	Supply current	VCC = MAX, All inputs at 4.5 V,			45	70	mA
		All outputs open	Ī		. •		,

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device

# switching characteristics. VCC = 5 V. TA 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH	A, B, or C	Y	•		12	18	
<sup>t</sup> PHL	(4 levels)	ţ	ļ		12	18	ns
tPLH	A, B, or C	w	1		10	15	
<sup>†</sup> PHL	(3 levels)				9	13.5	ns
tPLH	Any D	Y	0 45-5		8	12	
₹PHL	Any	,	C <sub>L</sub> = 15 pF,		8	12	ns
tpLH	Any D	W	R <sub>L</sub> = 280 kΩ, See Note 4		4.5	7	
tPHL	T ANY D	VV	See Note 4		4.5	7	ns
tpLH	Strobe G	Y			11	16.5	
tphL	3trope G	т			12	18	ns
<sup>t</sup> PLH	Strobe G	w			9	13	
tPHL	Strope G				8.5	12	กร

TtpLH = propagation delay time, low-to-high-level output



 $<sup>\</sup>ddagger$ All typical values are at  $\lor$ CC = 5  $\lor$ ,  $\lnot$ A = 25°C.  $\ddagger$ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

tpHL - propagation delay time, high-to-low-level output
NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

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# **PACKAGE OPTION ADDENDUM**

26-Sep-2005

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74LS151DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS151J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	Level-NC-NC-NC
SNJ54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	Level-NC-NC-NC

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microcontroller.ti.com	Security	www.ti.com/security
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	Wireless	www.ti.com/wireless
	dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com	amplifier.ti.com dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com www.ti.com/lpw  Audio Autiomotive Broadband Digital Control Military Potical Networking Security Telephony  Video & Imaging

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logic.ti.com	Military	www.ti.com/military
power.ti.com	Optical Networking	www.ti.com/opticalnetwork
microcontroller.ti.com	Security	www.ti.com/security
www.ti.com/lpw	Telephony	www.ti.com/telephony
	Video & Imaging	www.ti.com/video
	Wireless	www.ti.com/wireless
	dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com	amplifier.ti.com dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com www.ti.com/lpw  Audio Autiomotive Broadband Digital Control Military Potical Networking Security Telephony  Video & Imaging

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interface.ti.com	Digital Control	www.ti.com/digitalcontrol
logic.ti.com	Military	www.ti.com/military
power.ti.com	Optical Networking	www.ti.com/opticalnetwork
microcontroller.ti.com	Security	www.ti.com/security
www.ti.com/lpw	Telephony	www.ti.com/telephony
	Video & Imaging	www.ti.com/video
	Wireless	www.ti.com/wireless
	dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com	amplifier.ti.com dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com www.ti.com/lpw  Audio Autiomotive Broadband Digital Control Military Potical Networking Security Telephony  Video & Imaging

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Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	n MSL Peak Temp <sup>(3)</sup>
5962-9558001QJA	ACTIVE	CDIP	J	24	1	TBD	A42 SNPB	N / A for Pkg Type
5962-9558001QKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
5962-9558001QKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
5962-9751601Q2A	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
5962-9751601QCA	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
5962-9751601QDA	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
76010012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
76010012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7601001EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7601001EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7601001FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7601001FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/01401BKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
JM38510/01401BKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
JM38510/07901BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/30901B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30901B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30901BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30901BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/30901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54150J	ACTIVE	CDIP	J	24	1	TBD	A42 SNPB	N / A for Pkg Type
SN54150J	ACTIVE	CDIP	J	24	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S151J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74150N	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74150N	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74150NE4	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74150NE4	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74151AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74151AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)		Level-1-260C-UNLIM
SN74LS151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

# **PACKAGE OPTION ADDENDUM**

9-Oct-2007

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp (3)
SN74LS151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS151J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151DG4	ACTIVE	SOIC	D	16	40	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM





9-Oct-2007

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
						no Sb/Br)		
SN74S151DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54150J	ACTIVE	CDIP	J	24	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54150J	ACTIVE	CDIP	J	24	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54150W	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
SNJ54150W	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
SNJ54LS151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS151W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS151W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S151J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S151W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S15FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ54S15W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI

 $<sup>^{(1)}</sup>$  The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



# PACKAGE OPTION ADDENDUM

9-Oct-2007

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

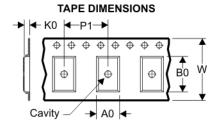
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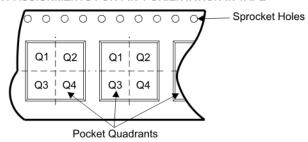
# TAPE AND REEL BOX INFORMATION

# REEL DIMENSIONS Reel Diameter Reel Width



	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
	Overall width of the carrier tape
P1	Pitch between successive cavity centers

# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package	Pins		Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS151DR	D	16	SITE 27	330	16	6.5	10.3	2.1	8	16	Q1
SN74LS151NSR	NS	16	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
SN74S151NSR	NS	16	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1

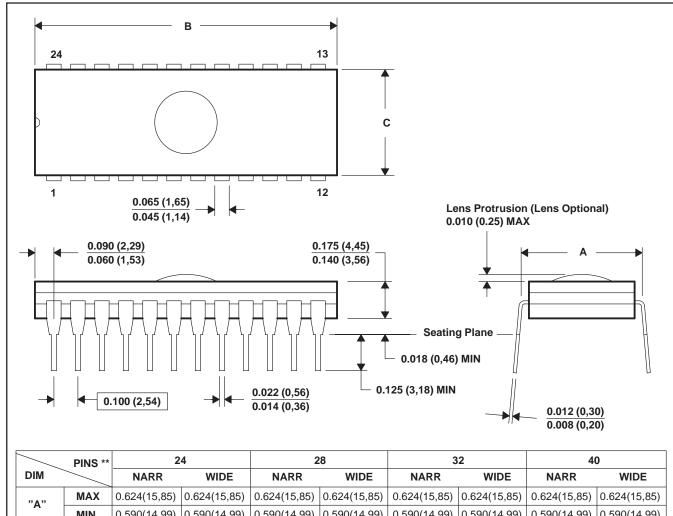


Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
SN74LS151DR	D	16	SITE 27	342.9	336.6	28.58
SN74LS151NSR	NS	16	SITE 41	346.0	346.0	33.0
SN74S151NSR	NS	16	SITE 41	346.0	346.0	33.0

# J (R-GDIP-T\*\*)

# 24 PINS SHOWN

# **CERAMIC DUAL-IN-LINE PACKAGE**



PINS **		2	4	28		32		40	
DIM		NARR	WIDE	NARR	WIDE	NARR	WIDE	NARR	WIDE
"A"	MAX	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)
	MIN	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)
"D"	MAX	1.265(32,13)	1.265(32,13)	1.465(37,21)	1.465(37,21)	1.668(42,37)	1.668(42,37)	2.068(52,53)	2.068(52,53)
В	MIN	1.235(31,37)	1.235(31,37)	1.435(36,45)	1.435(36,45)	1.632(41,45)	1.632(41,45)	2.032(51,61)	2.032(51,61)
"0"	MAX	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)
	MIN	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)
"B"	MIN	1.235(31,37) 0.541(13,74)	1.235(31,37) 0.598(15,19)	1.435(36,45) 0.541(13,74)	1.435(36,45) 0.598(15,19)	1.632(41,45) 0.541(13,74)	1.632(41,45) 0.598(15,19)	2.032(51,61) 0.541(13,74)	2.032(

4040084/C 10/97

- B. This drawing is subject to change without notice.
- C. Window (lens) added to this group of packages (24-, 28-, 32-, 40-pin).
- D. This package can be hermetically sealed with a ceramic lid using glass frit.
- E. Index point is provided on cap for terminal identification.

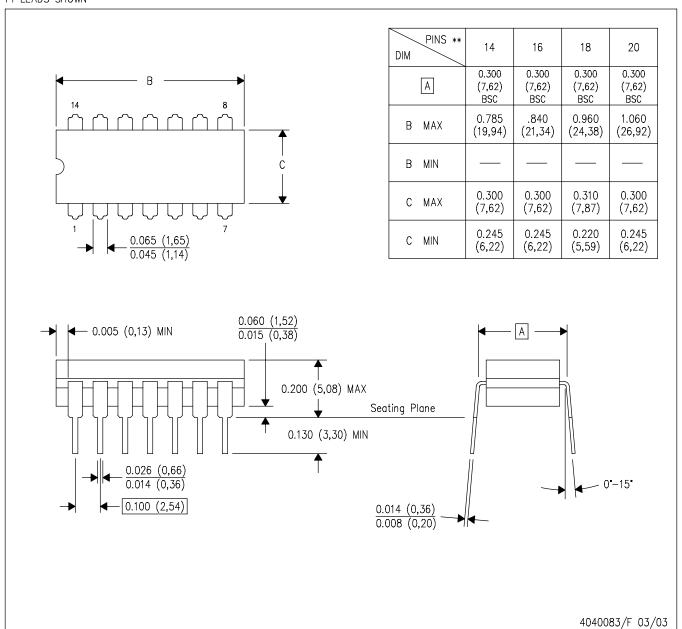


# 查询"SN54150\_07"供应商

# J (R-GDIP-T\*\*)

# CERAMIC DUAL IN-LINE PACKAGE

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# W (R-GDFP-F16)

# CERAMIC DUAL FLATPACK

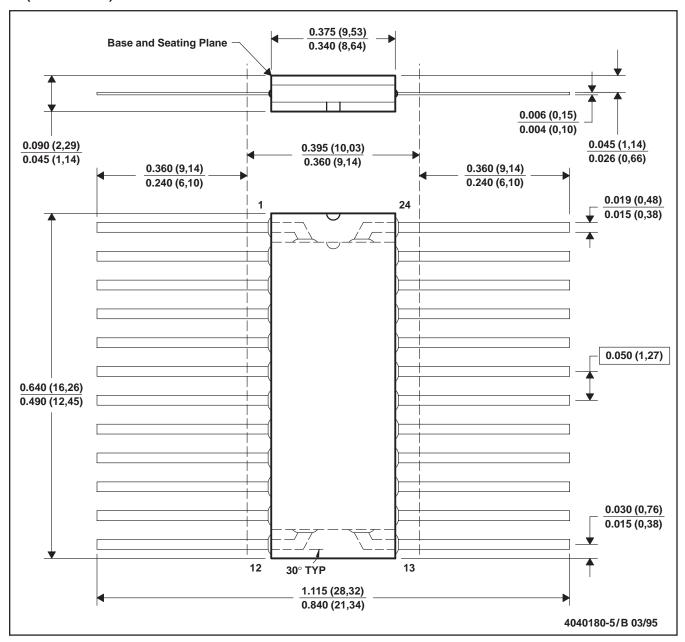


- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



# W (R-GDFP-F24)

# **CERAMIC DUAL FLATPACK**



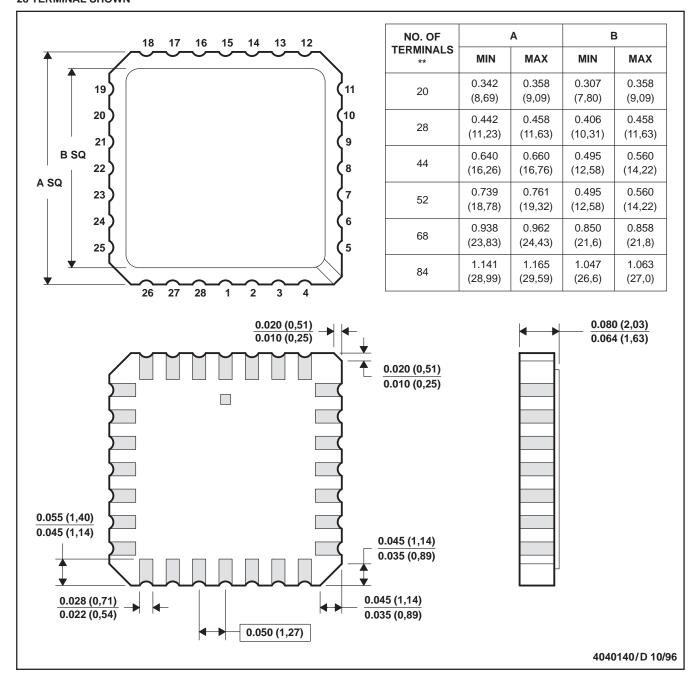
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Falls within MIL-STD-1835 GDFP2-F24 and JEDEC MO-070AD
- E. Index point is provided on cap for terminal identification only.



# FK (S-CQCC-N\*\*)

# **28 TERMINAL SHOWN**

# **LEADLESS CERAMIC CHIP CARRIER**



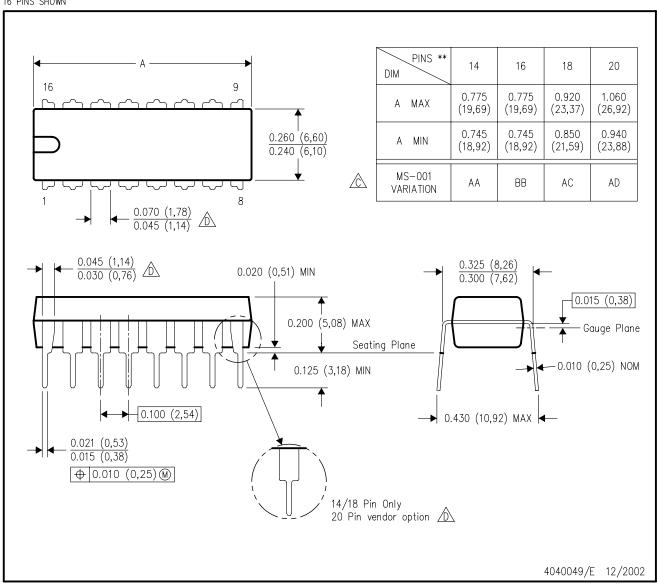
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



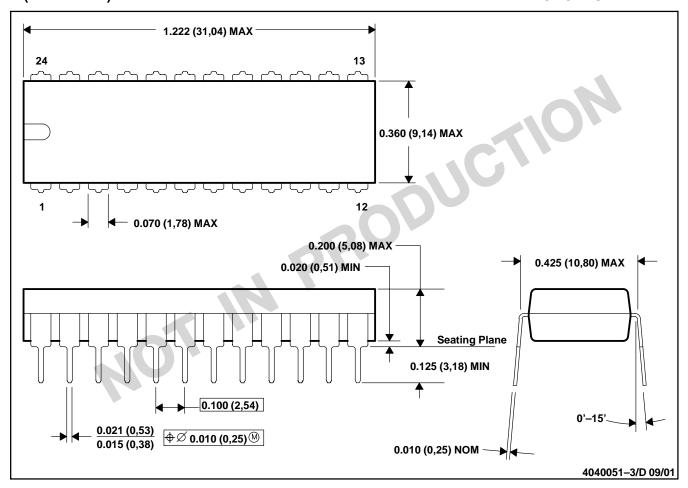
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# N (R-PDIP-T24)

# PLASTIC DUAL-IN-LINE



- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-010

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

# **24 PIN SHOWN**

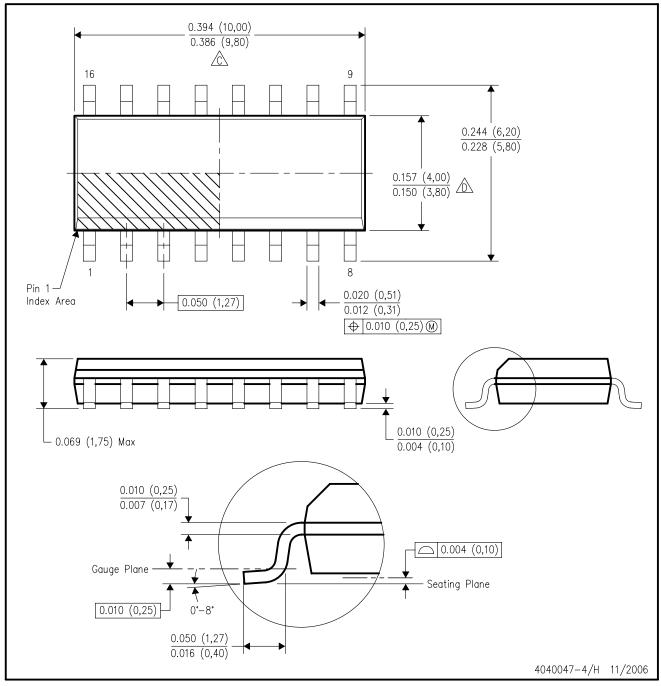


- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-011
- D. Falls within JEDEC MS-015 (32 pin only)



# D (R-PDSO-G16)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.

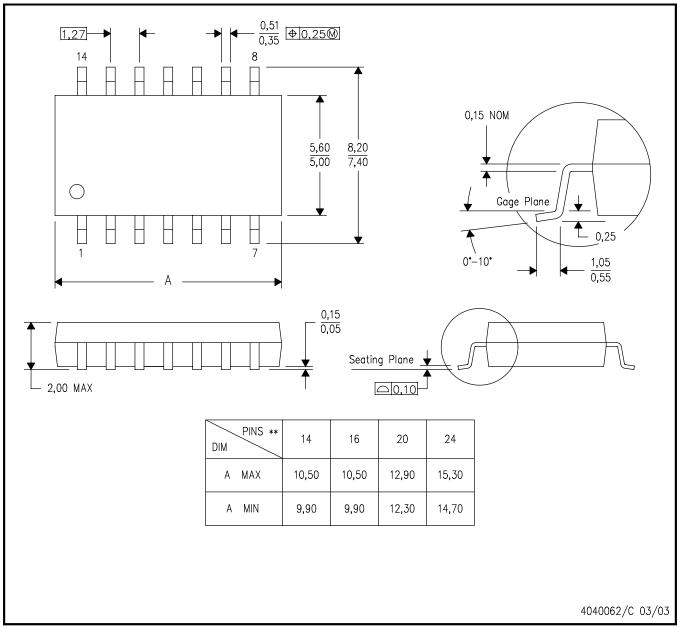


# **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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Low Power Wireless	www.ti.com/lpw	Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless